

MOSFET

OptiMOS[™]5 Power-Transistor, 100 V

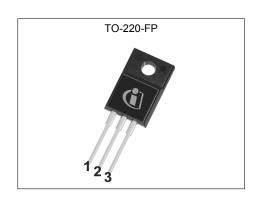
Features

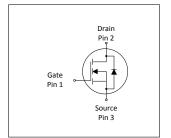
- Ideal for high frequency switching and sync. rec.
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit						
V _{DS}	100	V						
R _{DS(on),max}	8.3	mΩ						
I _D	44	A						
Q _{oss}	40	nC						
Q _G (0V10V)	30	nC						











Type / Ordering Code	Package	Marking	Related Links
IPA083N10N5	PG-TO220-FP	083N10N5	-

OptiMOS[™]5 Power-Transistor, 100 V



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OptiMOS[™]5 Power-Transistor, 100 V . IPA083N10N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Davamatav	Cumb al		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current	I _D	-	-	44 32	А	T _C =25 °C T _C =100 °C	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	176	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse	E AS	-	-	83	mJ	I_D =44 A, R_{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	36	W	<i>T</i> _C =25 °C	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

Thermal characteristics 2

Thermal characteristics Table 3

Davamatav	Cumbal	Values			I Imit	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	3.1	4.1	K/W	-	

3 **Electrical characteristics**

Table 4 **Static characteristics**

Davamatar	Comple al		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	2.2	3.0	3.8	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=49\ \mu {\rm A}$	
Zero gate voltage drain current	$I_{ m DSS}$	-	0.1 10	1 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	7.2 8.8	8.3 11.0	mΩ	V _{GS} =10 V, I _D =44 A V _{GS} =6 V, I _D =22 A	
Gate resistance ²⁾	R _G	-	1.2	1.8	Ω	-	
Transconductance	<i>g</i> fs	38	76	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 44 \text{ A}$	

 $^{^{1)}}$ see Diagram 3 $^{2)}$ Defined by design. Not subject to production test.

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Table 5 Dynamic characteristics¹⁾

Downwater.	Cumbal	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	2100	2730	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Output capacitance	Coss	-	337	438	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Reverse transfer capacitance	Crss	-	16	28	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Turn-on delay time	$t_{ m d(on)}$	-	15	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	5	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	24	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	5	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =44 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics²⁾

Development	Cumbal		Values			Nata / Tant Canadition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q gs	-	10	-	nC	V_{DD} =50 V, I_{D} =44 A, V_{GS} =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	6	10	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q _{sw}	-	10	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ¹⁾	Q g	-	30	37	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =44 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	4.8	-	V	V _{DD} =50 V, I _D =44 A, V _{GS} =0 to 10 V	
Output charge ¹⁾	Qoss	-	40	53	nC	V _{DD} =50 V, V _{GS} =0 V	

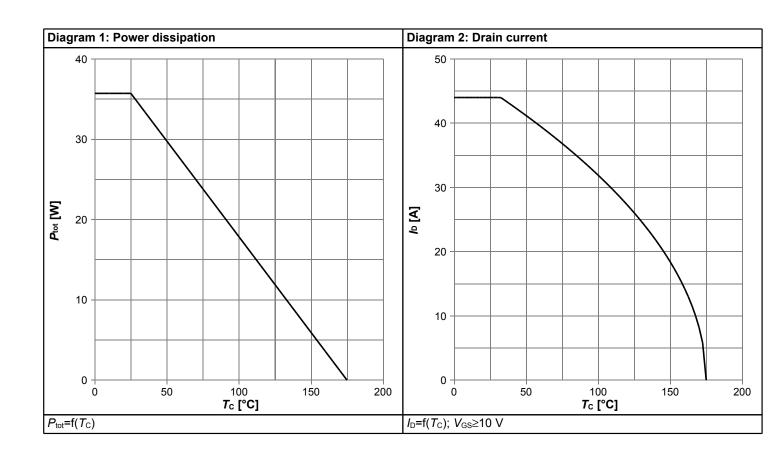
Table 7 Reverse diode

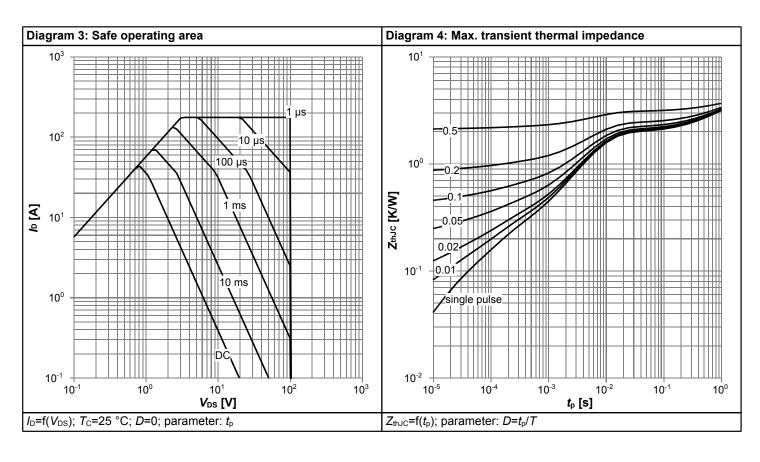
Doromotor	Cumbal	Values			11	Note / Tost Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	30	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	176	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.9	1.2	V	V _{GS} =0 V, I _F =44 A, T _j =25 °C	
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	55	110	ns	V_{R} =50 V, I_{F} = I_{S} , di_{F} / dt =100 A/ μ s	
Reverse recovery charge ¹⁾	Qrr	-	95	190	nC	V_{R} =50 V, I_{F} = I_{S} , di_{F} / dt =100 A/ μ s	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

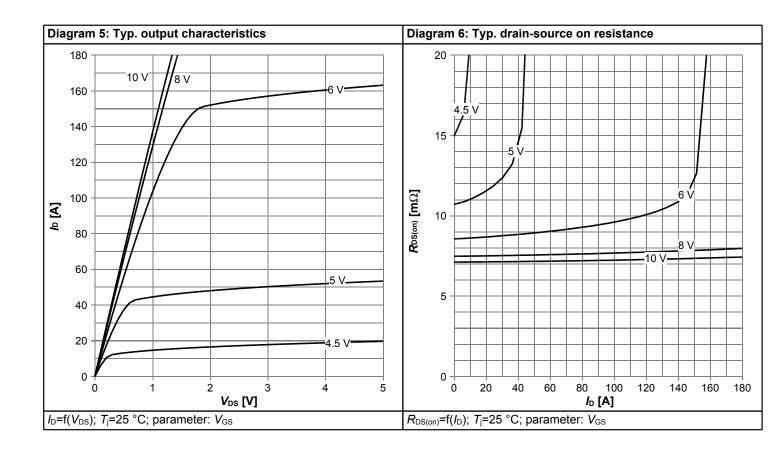


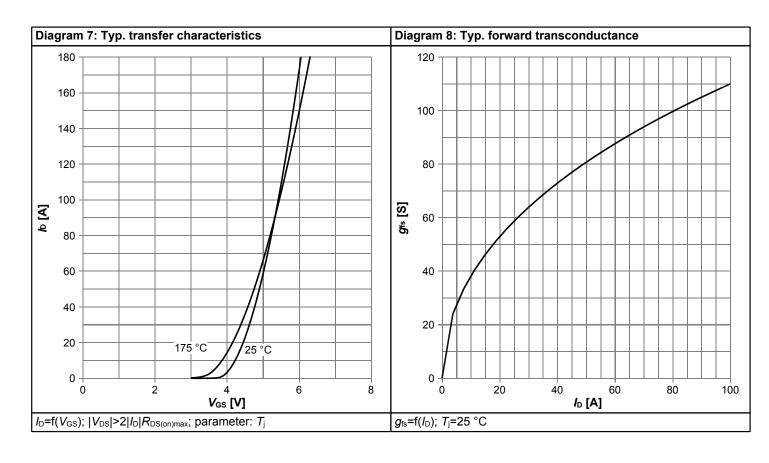
4 Electrical characteristics diagrams



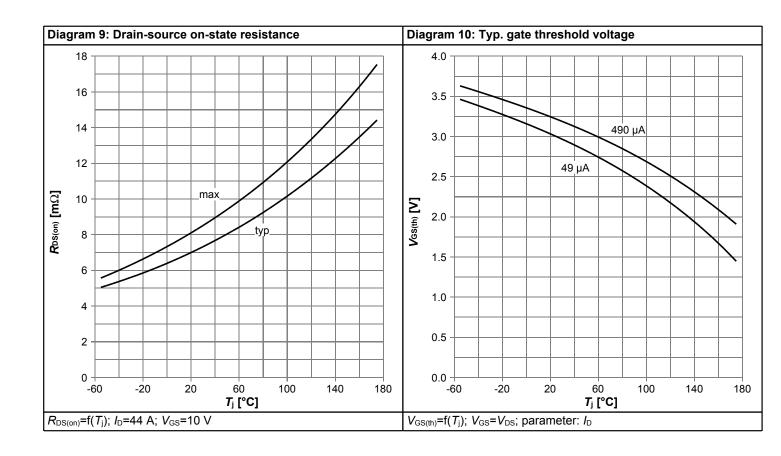


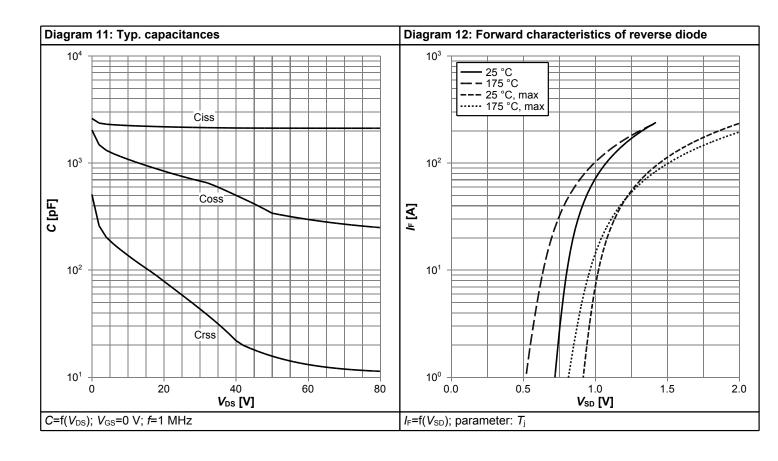




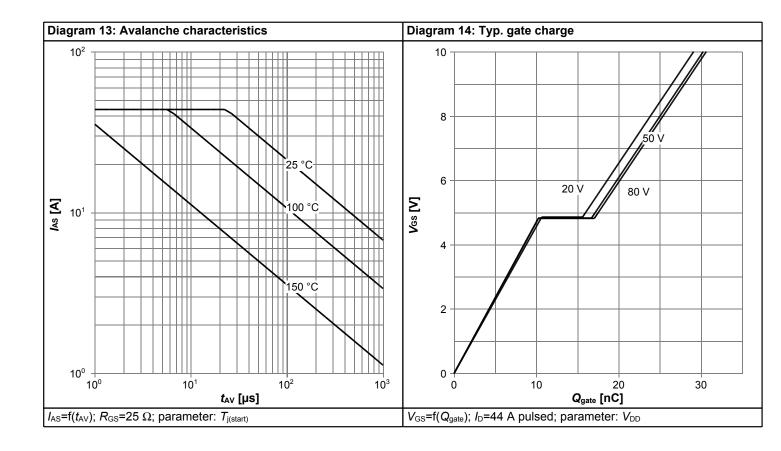


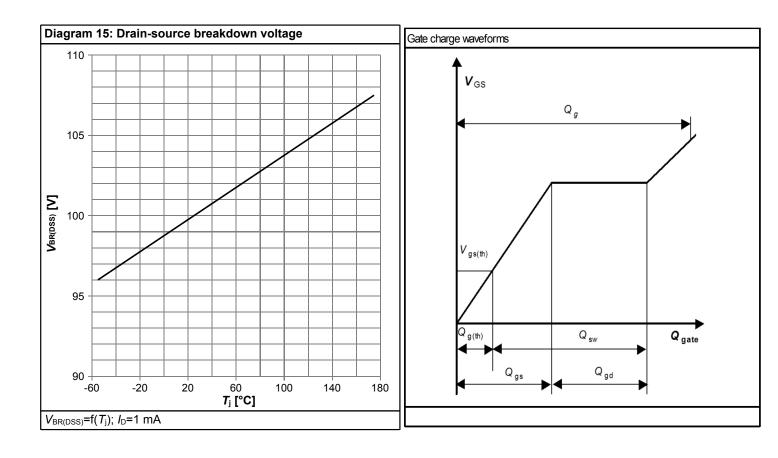






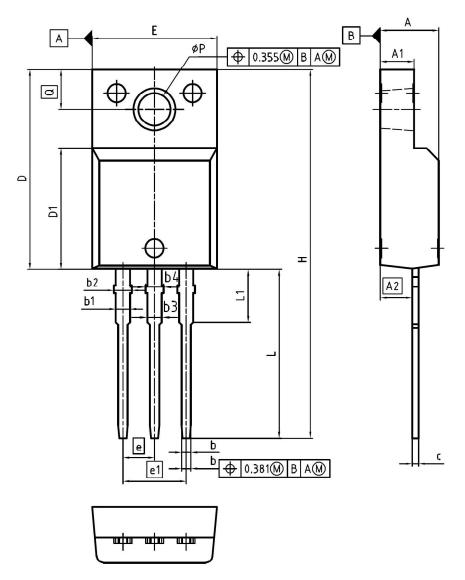








5 Package Outlines



DIM	MILLIM	ETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	4.55	4.85	0.179	0.191			
A1	2.55	2.85	0.100	0.112			
A2	2.42	2.72	0.095	0.107			
ь	0.65	0.85	0.026	0.033			
ь1	0.95	1.33	0.037	0.052			
b2	0.95	1.51	0.037	0.059			
b3	0.65	1.33	0.026	0.052			
b4	0.65	1.51	0.026	0.059			
С	0.40	0.63	0.016	0.025			
D	15.85	16.15	0.624	0.636			
D1	9.53	9.83	0.375	0.387			
E	10.35	10.65	0.407	0.419			
е	2.5	54	0.1	00			
e1	5.0)8	0.2	200			
N	;	3	;	3			
Н	29.45	29.75	1.159	1.171			
Ĺ	13.45	13.75	0.530	0.541			
L1	3.15	3.45	0.124	0.136			
øΡ	2.95	3.20	0.116	0.126			
Q	3.15	3.50	0.124	0.138			

DOCUMENT NO.

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SCALE

0
2.5

0
2.5

Smm

EUROPEAN PROJECTION

ISSUE DATE
08-03-2007

REVISION
03

Figure 1 Outline PG-TO220-FP, dimensions in mm/inches

OptiMOS[™]5 Power-Transistor, 100 V IPA083N10N5



Revision History

IPA083N10N5

Revision: 2016-10-03, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2014-12-18	Release of final version
2.1	2016-10-03	Update Avalanche Energy

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